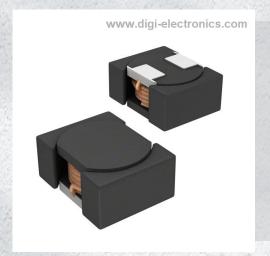


VLF252012MT-6R8M Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number VLF252012MT-6R8M-DG

Manufacturer TDK Corporation

Manufacturer Product Number VLF252012MT-6R8M

Description FIXED IND 6.8UH 890MA 340MOHM SM

Detailed Description 6.8 µH Shielded Drum Core, Wirewound Inductor 89

0 mA 340mOhm Max 1008 (2520 Metric)



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
VLF252012MT-6R8M	TDK Corporation
Series:	Product Status:
VLF-M	Obsolete
Type:	Material - Core:
Drum Core, Wirewound	Ferrite
Inductance:	Tolerance:
6.8 µН	±20%
Current Rating (Amps):	Current - Saturation (Isat):
890 mA	504mA
Shielding:	DC Resistance (DCR):
Shielded	340mOhm Max
Q @ Freq:	Frequency - Self Resonant:
Ratings:	Operating Temperature:
	-40°C ~ 105°C
Inductance Frequency - Test:	Mounting Type:
1 MHz	Surface Mount
Package / Case:	Supplier Device Package:
1008 (2520 Metric)	
Size / Dimension:	Height - Seated (Max):
0.098" L x 0.079" W (2.50mm x 2.00mm)	0.047" (1.20mm)

Environmental & Export classification

Moisture Sensitivity Level (MSL):	REACH Status:
1 (Unlimited)	REACH Unaffected
ECCN:	HTSUS:
EAR99	8504.50.4000



June 2017

Inductors for Power Circuits

Wound Ferrite

VLF-M Series

VLF252012MT Type

VLF252012MT



The products in this catalog will be or have been stopped production

Discontinue Issue Date	May 18, 2017
Last Purchase Order Date	Mar. 29, 2019
Last Shipment Date	Sep. 30, 2019

Please refer to our Web site about replacement information.



REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using these products.

⚠ REMINDERS
The storage period is less than 12 months. Be sure to follow the storage conditions (Temperature: 5 to 40°C, Humidity: 10 to 75% RH or less). If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.
Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
Carefully lay out the coil for the circuit board design of the non-magnetic shield type. A malfunction may occur due to magnetic interference.
Use a wrist band to discharge static electricity in your body through the grounding wire.
Do not expose the products to magnets or magnetic fields.
Do not use for a purpose outside of the contents regulated in the delivery specifications.
The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition. The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or

quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to

If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions

(1) Aerospace/Aviation equipment

society, person or property.

- (2) Transportation equipment (cars, electric trains, ships, etc.)
- (3) Medical equipment
- (4) Power-generation control equipment

set forth in the each catalog, please contact us.

- (5) Atomic energy-related equipment
- (6) Seabed equipment
- (7) Transportation control equipment

- (8) Public information-processing equipment
- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.



Inductors for Power Circuits

Wound Ferrite

Product compatible with RoHS directive
Halogen-free
Compatible with lead-free solders

Overview of VLF252012MT Type

FEATURES

- Magnetic shield type wound inductor for power circuits.
- A DC-DC converter with top-class voltage conversion efficiency for similar products was achieved by optimizing the magnetic material and configuration.
- Low-profile product.
- O High magnetic shield construction and compatible with high-density mounting.
- O Halogen-free compatible product.

APPLICATION

Smart phones, tablet terminals, HDDs, SSDs, DVCs, DSCs, mobile display panels, portable game devices, compact power supply modules, other

PART NUMBER CONSTRUCTION

VLF	252012		252012		M	I	-	R47		N
Series name	L×W×H Dimensions (mm max.)		internal code Packaging style		luctance (µH)					
	252012	2.5×2.0×1.2		T Taping	R47	0.47	М	±20%		
					1R5	1.5	N	±30%		
					220	22				

■ OPERATING TEMPERATURE RANGE, PACKAGE QUANTITY, PRODUCT WEIGHT

	Temperat	ure range	Package quantity	Individual weight
Туре	Operating temperature*	Storage temperature**		
	(°C)	(°C)	(pieces/reel)	(g)
VLF252012MT	-40 to +105	-40 to +105	2000	0.021

^{*} Operating temperature range includes self-temperature rise.

^{**} The Storage temperature range is for after the circuit board is mounted.

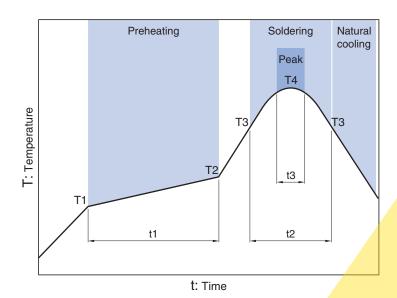
RoHS Directive Compliant Product: See the following for more details.https://product.tdk.com/info/en/environment/rohs/index.html

Halogen-free: Indicates that Cl content is less than 900ppm, Br content is less than 900ppm, and that the total Cl and Br content is less than 1500ppm.

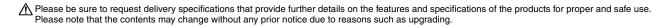


VLF252012MT Type

■ RECOMMENDED REFLOW PROFILE



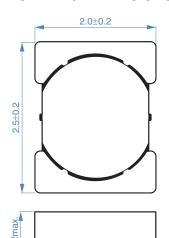
Preheati	ng		Soldering		Peak		
Temp.		Time	Temp.	Time	Temp.	Time	
T1	T2	t1	T3	t2	T4	t3	
150°C	180°C	60 to 120s	230°C	30s	260°C	10s	

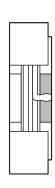


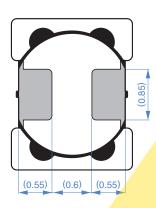


VLF252012MT Type

■SHAPE & DIMENSIONS

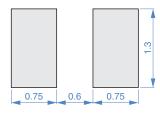






Dimensions in mm

■ RECOMMENDED LAND PATTERN



Dimensions in mm

A Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading.



VLF252012MT Type

ELECTRICAL CHARACTERISTICS

□ CHARACTERISTICS SPECIFICATION TABLE

L		Measuring frequency	DC resista	DC resistance Rated current*				Part No.
(μH)	Tolerance	(MHz)	(Ω)max.	(Ω)typ.	Isat (A)max.	Isat (A)typ.	Itemp (A)typ.	
0.47	±30%	1.0	0.029	0.024	1.89	2.10	3.45	VLF252012MT-R47N
0.68	±30%	1.0	0.038	0.032	1.55	1.72	3.04	VLF252012MT-R68N
1.0	±30%	1.0	0.052	0.043	1.30	1.44	2.47	VLF252012MT-1R0N
1.5	±30%	1.0	0.069	0.057	1.10	1.22	2.17	VLF252012MT-1R5N
2.2	±20%	1.0	0.10	0.09	0.94	1.04	1.67	VLF252012MT-2R2M
3.3	±20%	1.0	0.15	0.13	0.70	0.78	1.39	VLF252012MT-3R3M
4.7	±20%	1.0	0.22	0.18	0.62	0.69	1.09	VLF252012MT-4R7M
6.8	±20%	1.0	0.34	0.28	0.504	0.56	0.89	VLF252012MT-6R8M
10.0	±20%	1.0	0.41	0.34	0.41	0.46	0.78	VLF252012MT-100M
15.0	±20%	1.0	0.68	0.57	0.33	0.37	0.63	VLF252012MT-150M
22.0	±20%	1.0	1.00	0.83	0.28	0.31	0.46	VLF252012MT-220M

^{*} Rated current: smaller value of either lsat or Itemp.

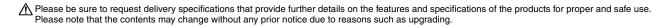
Isat: When based on the inductance change rate (30% below the nominal value)

Itemp: When based on the temperature increase (Temperature increase of 40°C by self heating)

O Measurement equipment

Measurement item	Product No.	Manufacturer
L	4294A	Keysight Technologies
DC resistance	VP-2941A	Panasonic
Rated current Isat	4285A+42841A+42842C	Keysight Technologies

^{*} Equivalent measurement equipment may be used.

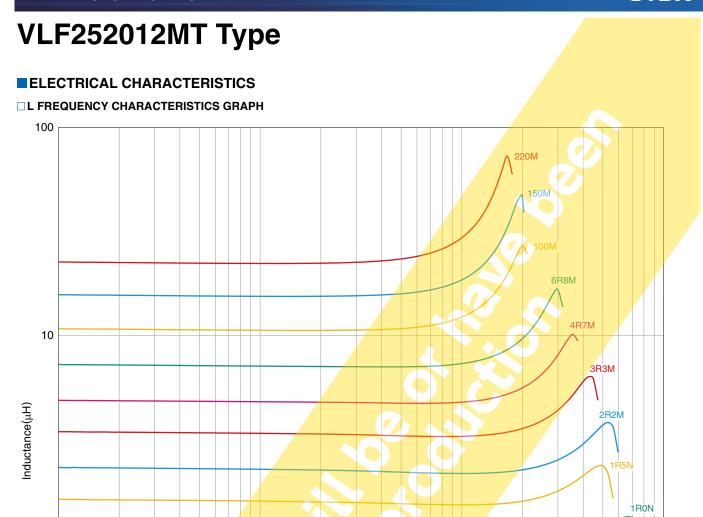




R68N

R47N

100





0.1 - 0.1

Product No. Manufacturer
4294A Keysight Technologies

Frequency(MHz)

10

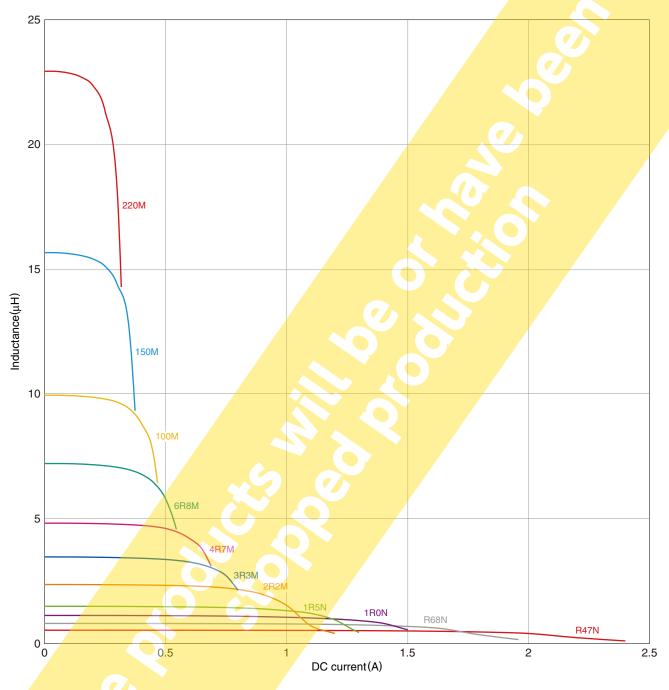
^{*} Equivalent measurement equipment may be used.





ELECTRICAL CHARACTERISTICS

□INDUCTANCE VS. DC BIAS CHARACTERISTICS GRAPH



O Measurement equipment

Product No. Manufacturer

4285A+42841A+42842C Keysight Technologies

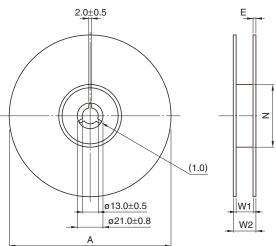
* Equivalent measurement equipment may be used.



VLF252012MT Type

■PACKAGING STYLE

REEL DIMENSIONS

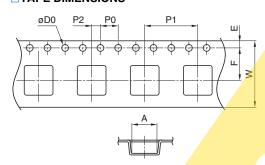


111636	values	aic	typical	values.

ø180

Type VLF252012MT

TAPE DIMENSIONS





Dimensions in mm

Dimensions in mm

Type	Α	В	øD0	É	F	P0	P1	P2	W	K	t
VLF252012MT	2.3	2.8	1.5+0.1/-0	1.75±0.1	3.50±0.1	4.0±0.1	4.00±0.1	2.00±0.05	8.00±0.2	1.35	0.25



OUR CERTIFICATE

DiGi provide top-quality products and perfect service for customer worldwide through standardization, technological innovation and continuous improvement. DiGi through third-party certification, we striciy control the quality of products and services. Welcome your RFQ to Email: Info@DiGi-Electronics.com

















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